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Pursuant to 37 C.F.R. 1.10
By Nona Washington
Nona Washington

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a Corr.
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Attorney Docket No.: NECN 18.947 (100806-17405)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventors : GOROU IKEGAMI.
Serial No. : 09/939,457
Filed : August 24, 2001
Title : CHIP-TYPE SEMICONDUCTOR DEVICE
Examiner : Volita Russell
Group Art Unit : 2822

February 7, 2003

Commissioner for Patents
Washington, D.C. 20231

AMENDMENT

Sir:

In response to the Office Action mailed on dated October 7, 2002, the period for responding thereto responding expiring after January 7, 2003, please amend the above-captioned application as follows:

IN THE SPECIFICATION

Please rewrite the paragraph beginning on page 8, line 20, and ending on page 9, line 2, as follows:

a¹
The resultant array of chips on the adhesive sheet 18 is then taken out from the work table 20, and the adhesive sheet 18 is subjected to extension in the diagonal